REMARKS/ARGUMENTS

The applicant's attorneys appreciate the Examiner's comments.

Enclosed herewith is a new Oath. Entry of the new Oath is requested.

In the Office Action, it has been stated that Kagawa shows "at least one power device (6)" and "a lead frame (3) including a conductive pad having large area to receive the power device." However, as seen in Figure 1(b), power device 6 is disposed on pad 4, which is isolated from conductive pad 3. Thus, as noted in the previous papers, Kagawa does not show a power module in which the power device resides on a pad that is integral with a lead.

Furthermore, claim 1 calls for a conductive pad, "said conductive pad having a first open surface area large enough to receive said at least one power semiconductor device and a second open surface opposite said first open surface exposed through said opening in said housing element."

It has been stated in the Office Action that "The housing element (13) in Kagawa does not have the bottom portion; that is the opening in the housing element through which a surface of the conductive pad opposite to the surface on which the die resides is exposed."

It appears that the Office Action confirms that Kagawa does not anticipate claim 1.

For the above reasons, and other reasons set forth in the record, it is respectfully submitted that Kagawa does not anticipate claim 1, and claims depending from claim 1. Reconsideration is requested.

The application is believed to be in condition for allowance. Such action is earnestly solicited.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on September 19, 2005:

Kourosh Salehi

Name of applicant, assignee or Registered Representative

Signature

September 19, 2005

Date of Signature

SHW:KS:ck

Respectfully submitted,

Kourosh Salehi

Registration No.: 43,898

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J. C.	COMBINED D		ON AND I		PATENT APPLICATION				OFGS FILE NO. IR-2553 CIP (2-3627)				
As a bolow named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verify believe that I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named) of the subject matter which is claimed and for which a patent is sought on the invention entitled: LOW COST POWER SEMICONDUCTOR MODULE WITHOUT SUBSTRATE													
I hereb sates probefore that	ication of whice s filed on Allication number by state that I had referred to a owledge the dury claim priority visional application of the applic	h is atlached IGUST r 10/6 tva reviewed pove, y to disclose benefits un ation(s) liste tion on which	hereto, ur 6, 20 35, 35 and under e all inform der Title 3 d holow an h priority ion(s) A	nicss the following the constion knowns, United S d have also is claimed:	lowing box is checked and v entents of the above ic on to be material to pat tates Code §119 of an identified below any i	s United a vas amended sentified a contability y foreign appropriate a contability of the	States particular description of the state o	rdent A Feb stion, in rdence lon(s): n for p	pplication Tuax neluding with Titl	n Number Y 22, the claims, le 37, Code t or inventor's c	or PCT Inte 2005 as amende of Federal or's certificate ha ertificate ha PRIOR UNDER	d by any Regulations,	
I hereby claim the beriefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Foderal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.													
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I hereby appoint customer no. 2352 OSTROLENK, FABER, GERB & SOFFEN, I.I.P., and the members of the firm, Samuel H. Weiner - Reg. No. 18,510; Robert C. Faber - Reg. No. 24,322; Max Moskowitz - Reg. No. 30,576; James A. Finder - Reg. No. 30,173; William O. Gray, III - Reg. No. 30,625, and Douglas A. Mino - Roy. No. 31,643, as attorneys with full power of substitution and revocation to prosecute this application, to transact all business in the Patent & Trademark Office connected therewith and to receive all correspondence. SRND CORRESPONDENCE TO: OSTROLENK, FABER, GERB & SOFFEN, LLP 1180 AVENUE OF THE AMERICAS NEW YORK, NEW YORK 10036-8403 CUSTOMER NO. 2352 OCCUSTOMER NO. 2352													
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent seved thereon.													
FULL NAME OF SOLE OR FIRST INVENTOR INVENTOR'S SIGNATUL WILLIAM GRANT ULLIAM									<i>[</i> .	DATE /	SEP/05	5	
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FOST OFFICE ADDRESS 1085 LA FONDA CIRCLE, FOUNTAIN VALLEY, CALIFORNIA 92707													
	OF SECOND JO				INVENTOR'S SIGNAT					DATE			
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